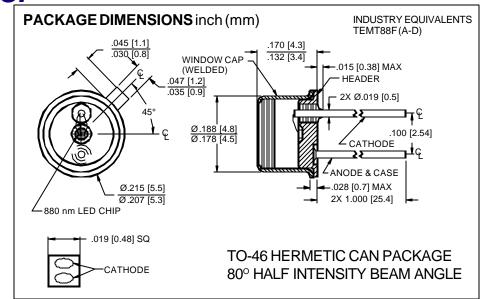
# **PHOTONIC DETECTORS INC.**

## **High-Power & Current GaAIAs Infrared Emitters** Peak Wavelength 880 nm, Type PDI-E811





## **FEATURES**

- Dual cathode
- High current
- Medium- high emission angle

**DESCRIPTION:** The **PDI-E811** infrared emitting diode uses dual cathode, high current reliability liquid phase epitaxially grown GaAlAs. Optimized for high power, high current at 880 nm. Packaged in a TO-46

can with a flat glass window cap.

**ABSOLUTE MAXIMU** M RATING (TA=25°C unless otherwise noted)

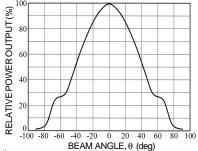
SYMBOL	PARAMETER	MIN	MAX	UNITS			
Pd	Power Dissipation		360	mW			
I <sub>P</sub>	Continuous Forward Current		180	mA			
I <sub>P</sub>	Peak Forward Current (100μs pulse,10pps	)	3.0	Α			
$V_R$	Reverse voltage		3.0	V			
To & Ts	Storage & Operating Temperature	-65	+125	°C			
TS	Soldering Temperature*		+260	°C			

<sup>\*1/16</sup> inch from case for 3 secs max

- Photoelectric switches
- Reflective switches
- Smoke detectors

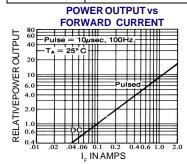
**APPLICATIONS** 

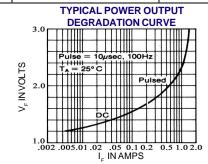
### **TYPICAL RADIATION PATTERN**

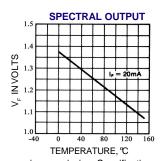


## ELECTRO-OPTICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Po	Output Power	I <sub>F</sub> = 100 mA	7.0	15		mW
VF	Forward Voltage	I <sub>F</sub> = 100 mA		1.5	1.9	V
lR	Reverse Current	V <sub>R</sub> = -3.0 V			10	μΑ
λp	Peak Wavelength	I <sub>F</sub> = 50 mA	865	880	895	nm
$\mathbb{A}\lambda$	Spectral Halfwidth	I <sub>F</sub> = 50 mA		80		nm
R₀	Dynamic Resistance	I <sub>F</sub> = 100 mA		1.2		Ohm
tr	Rise Time	I <sub>F</sub> = 100 mA		0.6		μS
tf	Fall Time	I <sub>F</sub> = 100 mA		0.5		μS







Information in this technical data sheet is believed to be correct and reliable. However, no responsibility is assumed for possible inaccuracies or omission. Specifications  $are subject to change without notice. Optical power and radiant intensity measured using uncapped dimpled TO-46 into integrating sphere. \\ [FORMNO.100-PDI-E811REVD]$